Initial Release



Features

Ш	Low	threshold,	-2.4V	max.
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- High input impedance
- Low input capacitance, 110pFmax.
- ☐ Fast switching speeds
- Low on resistance
- ☐ Free from secondary breakdown
- Low input and output leakage
- Complementary N- and P-channel devices

Application

- Logic level interfaces-ideal for TTL and CMOS
- Battery operated systems
- Photo voltaic devices
- Analog switches
- ☐ General purpose line drivers
- ☐ Telecom switches

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	±20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature****	300°C

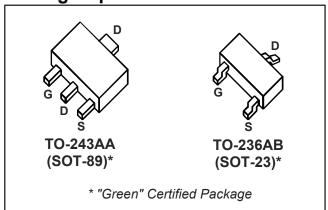
^{****}Distance of 1.6mm from case for 10 seconds.

General Description

These low threshold enhancement-mode (normally-off) transistors utilize an advanced vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



Ordering Information

Order Number / Package		BV _{DSS} /	R _{DS(ON)}	V _{GS(th)}	I _{D(ON)}	
TO-243AA**	TO-236AB***	BV _{DGS}	(max)	(max)	(min)	
TP5322N8	TP5322K1	-220V	12Ω	-2.4V	-0.7A	
TP5322N8-G*	TP5322K1-G*	-220V	12Ω	-2.4V	-0.7A	

^{**}Same as SOT-89. Product supplied on 2000 piece carrier tape reels.

^{***}Same as SOT-23. Products supplied on 3000 piece carrier tape reels.



Product Marking for SOT-89

TP3C*

Where *****=2-week alpha date code

Product Marking for SOT-23

P3C∗

Where ★=2-week alpha date code

A042005

Thermal Characteristics

Package	I _D (continuous)	I _D (pulsed)	Power Dissipation @ T _A = 25°C	°C/W	θ _{JA} °C/W	I _{DR} *	I _{DRM}
TO-243AA	-0.26A	-0.90A	1.6W	15	78**	-0.26A	-0.9A
TO-236AB	-0.12A	-0.70A	0.36W	200	350	-0.12A	-0.7A

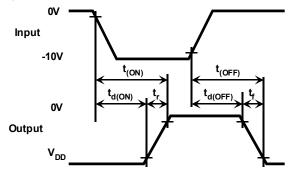
^{*}I_D(continous) is limited by max rated Tj.

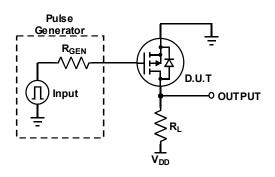
Electrical Characteristics (@25°C unless otherwise specified)

Symbol	Parameter	Min	Тур	Max	Units	Conditions
BV _{DSS}	Drain-to-Source	-220			V	$V_{GS} = 0V$, $I_D = -2mA$
	Breakdown Voltage					
$V_{GS(th)}$	Gate Threshold Voltage	-1.0		-2.4	V	$V_{GS} = V_{DS}$, $I_D = -1mA$
$\Delta V_{GS(th)}$	Change in V _{GS(th)} with Temperature			4.5	mV/°C	$V_{GS} = V_{DS}$, $I_D = -1mA$
I_{GSS}	Gate Body Leakage			-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
I_{DSS}	Zero Gate Voltage Drain Current			-10	μΑ	$V_{GS} = 0V$, $V_{DS} = Max$ Rating
				-1.0	mA	$V_{GS} = 0V, V_{DS} = 0.8 \text{ Max}$
						Rating, T _A = 125°C
$I_{D(ON)}$	On-State Drain Current	-0.7	-0.95		Α	$V_{GS} = -10V, V_{DS} = -25V$
R _{DS(ON)}	Static Drain-to-Source		10	15	Ω	$V_{GS} = -4.5V$, $I_D = -100mA$
, ,	ON-State Resistance		8.0	12		$V_{GS} = -10V, I_D = -200mA$
$\Delta R_{DS(ON)}$	Change in R _{DS(ON)} with Temperature			1.7	%/°C	$V_{GS} = -10V, I_D = -200mA$
G_{FS}	Forward Transconductance	100	250		mmho	$V_{DS} = -25V, I_{D} = -200mA$
C_{ISS}	Input Capacitance			110		$V_{GS} = 0V, V_{DS} = -25V$
C_{OSS}	Common Source Output Capacitance			45	pF	f = 1MHz
C_{RSS}	Reverse Transfer Capacitance			20		
$t_{d(ON)}$	Turn-ON Delay Time			10		$V_{DD} = -25V$,
t _r	Rise Time			15	ns	$I_{D} = -0.7A$
t _{d(OFF)}	Turn-Off Delay Time			20		$R_{GEN} = 25 \Omega$
t _f	Fall Time			15		
V_{SD}	Diode Forward Voltage Drop			-1.8	V	$V_{GS} = 0V, I_{SD} = -0.5A$
t _{rr}	Reverse Recovery Time		300		ns	$V_{GS} = 0V, I_{SD} = -0.5A$

Notes:

Switching Waveforms and Test Circuit





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^{**}Mounted on FR4 board, 25mm x 25mm x 1.57mm. Significant PD increase possible on ceramic substate.

¹⁾ All DC parameters 100% tested at 25°C unless otherwise stated. (Pulsed test: 300µs pulse at 2% duty cycle.)

²⁾ All AC parameters sample tested.